Product Specification

PE42441

UltraCMOS® SP4T RF Switch
10 MHz – 8 GHz

Features

- Four symmetric 50Ω absorptive ports
- High isolation
  - 45 dB @ 3 GHz
  - 39 dB @ 6 GHz
  - 31 dB @ 8 GHz
- Low insertion loss
  - 0.8 dB @ 3 GHz
  - 1.0 dB @ 6 GHz
  - 1.2 dB @ 8 GHz
- High linearity
  - 58 dBm IIP3 @ 8 GHz
  - 110 dBm IIP2 @ 8 GHz
- 1.8V control logic compatible
- ESD performance
  - 2 kV HBM on all pins
  - 100V MM on all pins
  - 1 kV CDM on all pins

Product Description

The PE42441 is a HaRP™ technology-enhanced absorptive SP4T RF switch designed for use in various switching applications spanning multiple markets including wireless infrastructure, broadband, and wireless connectivity.

This switch has four symmetric RF ports and delivers low insertion loss and exceptional isolation. An on-chip CMOS decode logic facilitates a two-pin low voltage CMOS control interface. In addition, no external blocking capacitors are required if 0 VDC is present on RF ports.

The PE42441 is manufactured on pSemi's UltraCMOS® process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate.

pSemi's HaRP™ technology enhancements deliver high linearity and excellent harmonics performance. It is an innovative feature of the UltraCMOS® process, offering the performance of GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Diagram

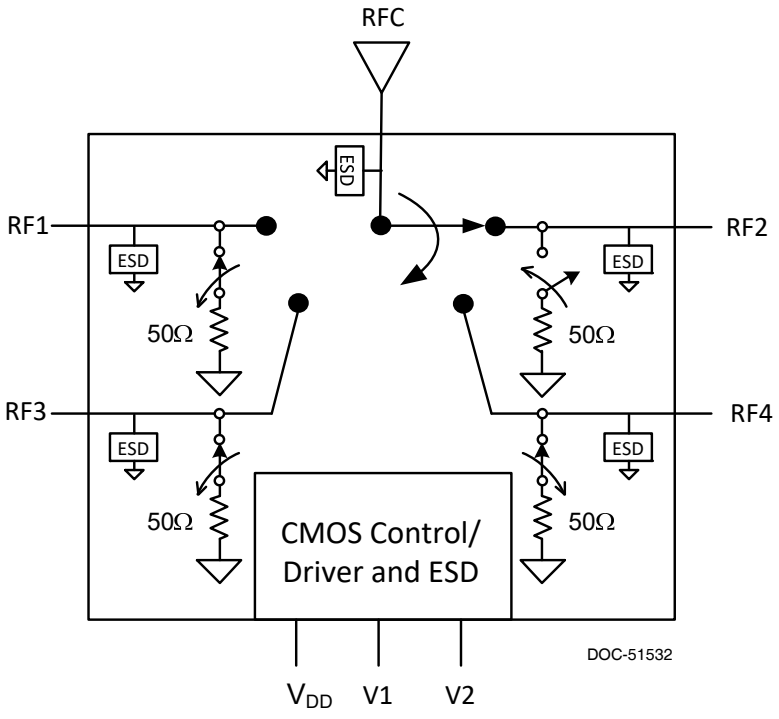
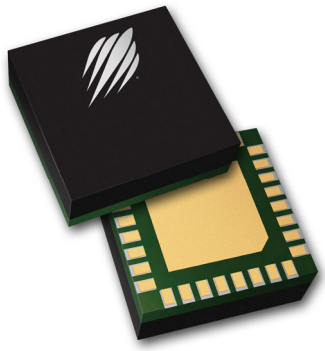


Figure 2. Package Type

32-lead 5x5 mm LGA



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Table 1. Electrical Specifications @ 25°C, V_{DD} = 3.3V (Z_S = Z_L = 50Ω), unless otherwise specified

Parameter	Path	Condition	Min	Typ	Max	Unit
Operating frequency			10 MHz		8 GHz	
Insertion loss	RFC-RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz		0.8 1.0 1.1 1.2	1.1 1.3 1.5 1.6	dB dB dB dB
Isolation (active port to terminated port)	RFX-RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz	40 34 27 25	45 39 32 31		dB dB dB dB
Isolation (common port to active port)	RFC-RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz	40 28 24 21	45 33 29 27		dB dB dB dB
Return loss (common port)	RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz		23 18 14 13		dB dB dB dB
Return loss (active port)	RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz		23 18 17 16		dB dB dB dB
Return loss (terminated port)	RFX	10 MHz – 3000 MHz 3000 MHz – 6000 MHz 6000 MHz – 7500 MHz 7500 MHz – 8000 MHz		18 13 11 10		dB dB dB dB
Input 0.1 dB compression point[1]	RFC-RFX	10 MHz – 8000 MHz		31		dBm
Input IP3	RFC-RFX	8000 MHz		58		dBm
Input IP2	RFC-RFX	8000 MHz		110		dBm
Switching time		50% CTRL to 90% or 10% RF		5	8	µs
Settling time		50% CTRL to 0.05 dB final value (–40 to +85°C) rising edge 50% CTRL to 0.05 dB final value (–40 to +85°C) falling edge		14 15	18 45	µs µs

Note 1: The input 0.1dB compression point is a linearity figure of merit. Refer to *Table 3* for the operating RF input power (50Ω).

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Figure 3. Pin Configuration (Top View)

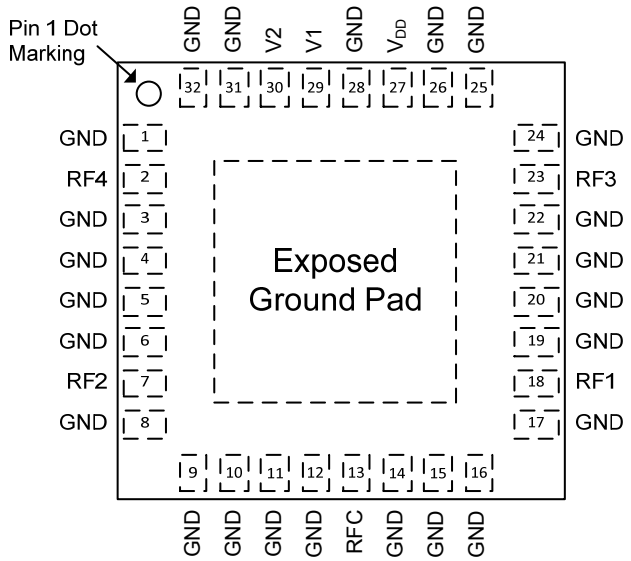


Table 2. Pin Descriptions

Pin #	Pin Name	Description
1, 3-6, 8, 9-12, 14-17, 19-22, 24-26, 28, 31, 32	GND	Ground
2	RF4[1]	RF port
7	RF2[1]	RF port
13	RFC[1]	RF common
18	RF1[1]	RF port
23	RF3[1]	RF port
27	V_{DD}	Supply voltage
29	V1	Digital control logic input 1
30	V2	Digital control logic input 2
Pad	GND	Exposed pad: Ground for proper operation

Note 1: RF pins 2, 7, 13, 18, and 23 must be at 0V DC. The RF pins do not require DC blocking capacitors for proper operation if the 0V DC requirement is met

Table 3. Operating Ranges

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{DD}	3.0	3.3	3.55	V
Supply current	I_{DD}		90	160	µA
Digital input high (V1, V2)	V_{IH}	1.2	1.5	V_{DD}	V
Digital input low (V1, V2)	V_{IL}	0	0	0.4	V
Digital input current	I_{CTRL}			1	µA
RF input power, CW[1] 10 MHz – 8 GHz	$P_{MAX,CW}$			See *Fig. 4*	dBm
RF input power into terminated ports, CW 10 MHz – 8 GHz	$P_{MAX,TERM}$			+20	dBm
Operating temperature range	T_{OP}	–40		+85	°C

Notes: 1. 100% duty cycle (–40 to +85°C, 1:1 VSWR)

Table 4. Absolute Maximum Ratings

Parameter/Condition	Symbol	Min	Max	Unit
Supply voltage	V_{DD}	–0.3	4.0	V
Digital input voltage (V1, V2)	V_{CTRL}	–0.3	4.0	V
Maximum input power 10 MHz – 8 GHz	$P_{MAX,ABS}$		See *Fig. 4*	dBm
Storage temperature range	T_{ST}	–60	+150	°C
ESD voltage HBM[1], all pins	$V_{ESD,HBM}$		2	kV
ESD voltage MM[2], all pins	$V_{ESD,MM}$		100	V
ESD voltage CDM[3], all pins	$V_{ESD,MM}$		1	kV

Notes: 1. Human Body Model (MIL-STD 883 Method 3015.7)
2. Machine Model (JEDEC JESD22-A115-A)
3. Charged Device Model (JEDEC JESD22-C101)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended

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Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS® device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS® devices are immune to latch-up.

Switching Frequency

The PE42441 has a maximum 25 kHz switching rate. Switching frequency describes the time duration between switching events. Switching time is the time duration between the point the control signal reaches 50% of the final value and the point the output signal reaches within 10% or 90% of its target value.

Table 5. Truth Table

State	V1	V2
RF1 on	0	0
RF2 on	1	0
RF3 on	0	1
RF4 on	1	1

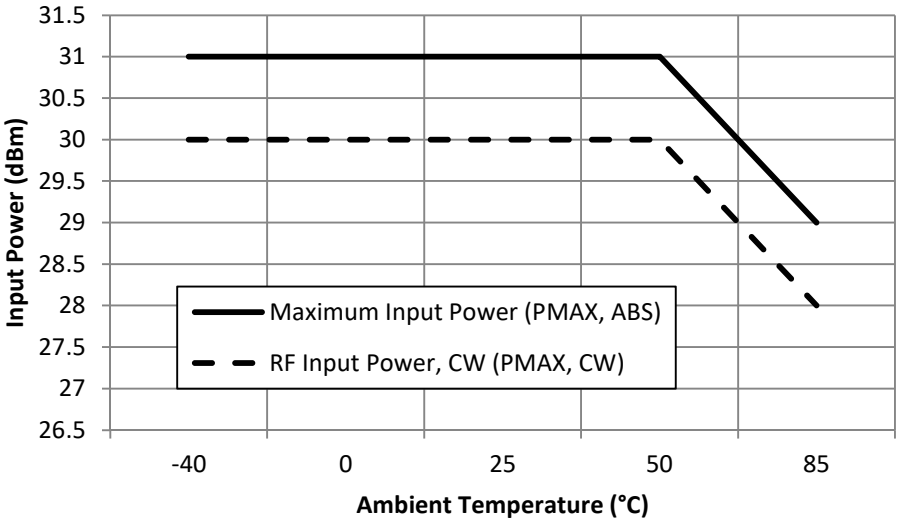
Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE42441 in the 32-lead 5x5 mm LGA package is MSL3.

Spurious Performance

The typical spurious performance of the PE42441 is -159 dBm/Hz.

Figure 4. Power De-rating Curve vs Temperature



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Typical Performance Data @ 25°C and V_{DD} = 3.3V unless otherwise specified

Figure 5. Insertion Loss (RFC-RFX)

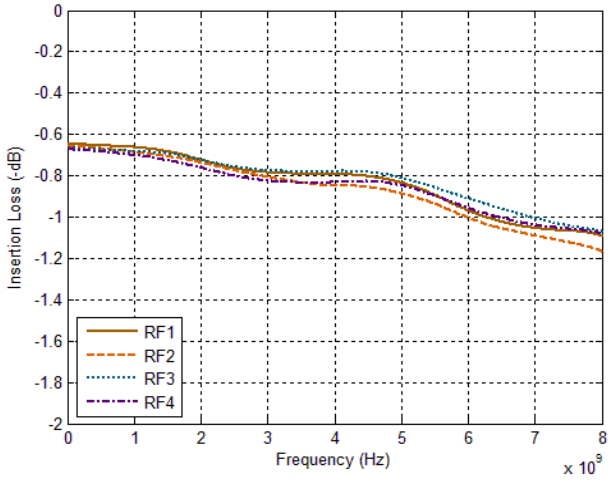


Figure 6. Insertion Loss vs. Temp (RFC-RFX)

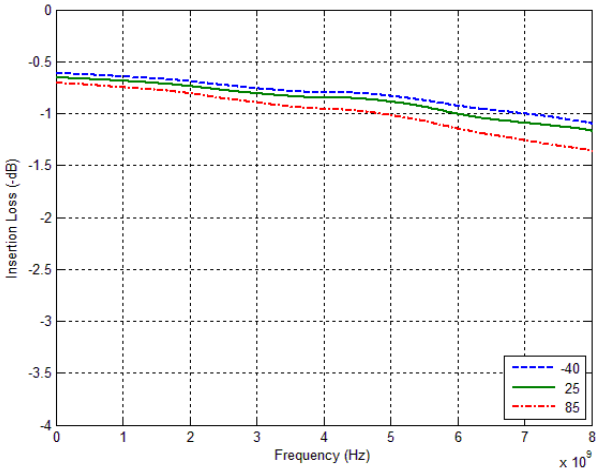
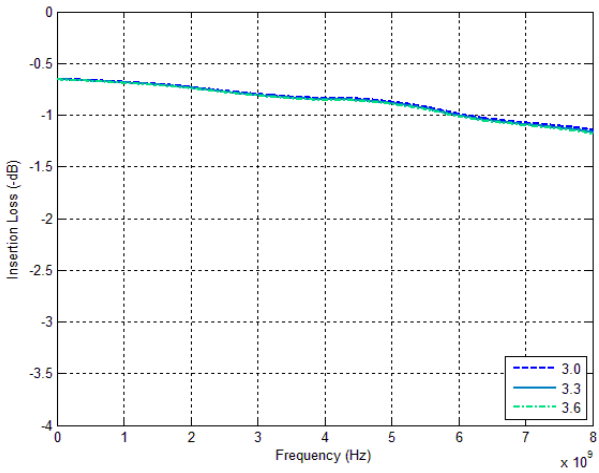


Figure 7. Insertion Loss vs. V_{DD} (RFC-RFX)



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Typical Performance Data @ 25°C and V_{DD} = 3.3V, unless otherwise specified

Figure 8. RFC Port Return Loss vs. Temp

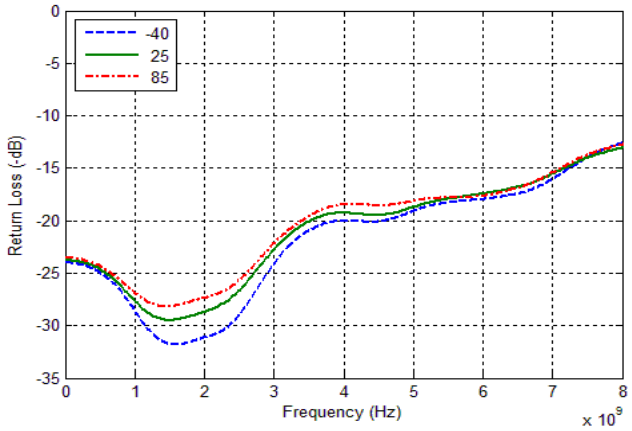


Figure 9. RFC Port Return Loss vs. V_{DD}

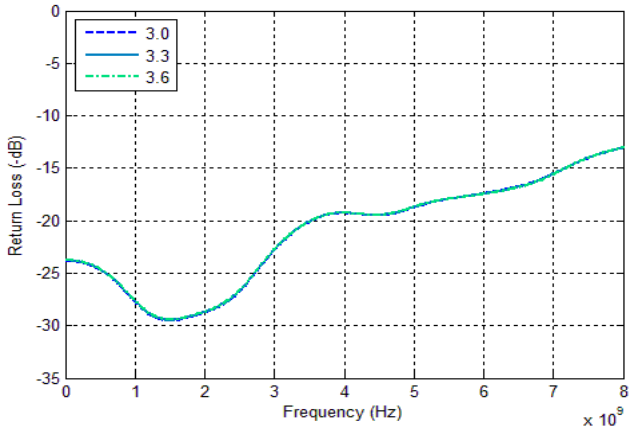


Figure 10. Active Port Return Loss vs. Temp

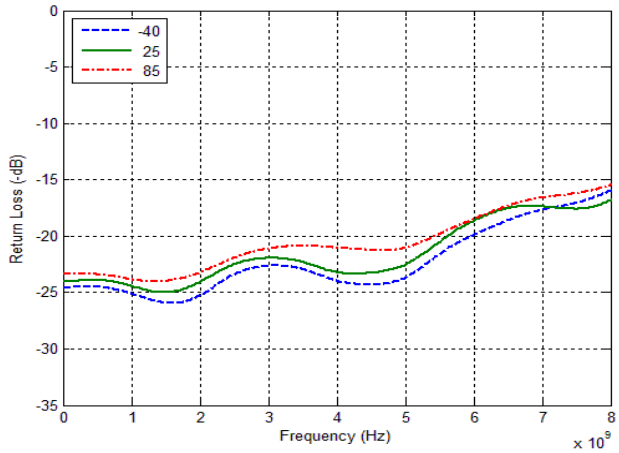
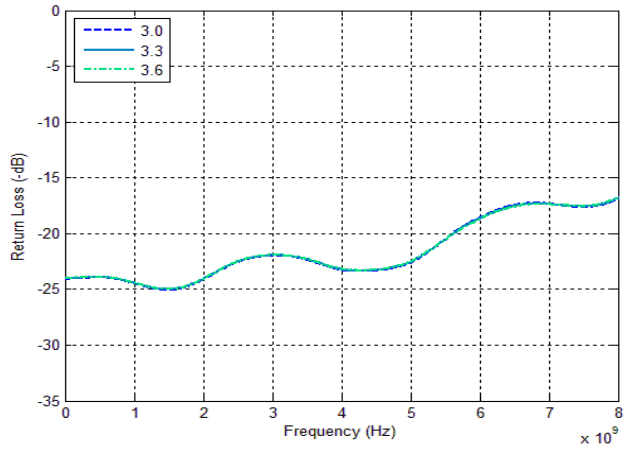


Figure 11. Active Port Return Loss vs. V_{DD}



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Typical Performance Data @ 25°C and V_{DD} = 3.3V, unless otherwise specified

Figure 12. Terminated Port Return Loss vs. Temp

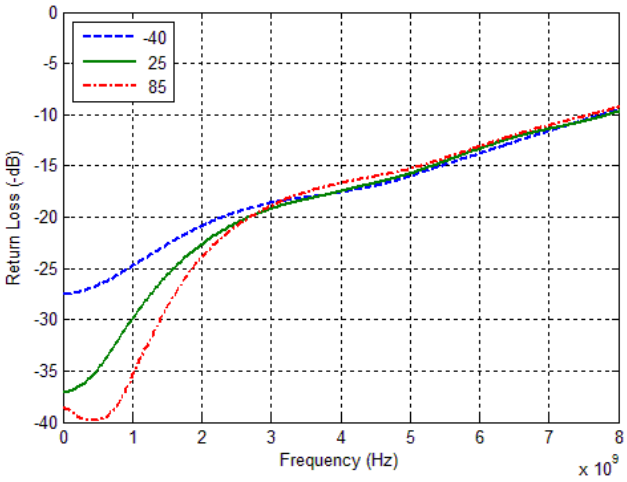


Figure 13. Terminated Port Return Loss vs. V_{DD}

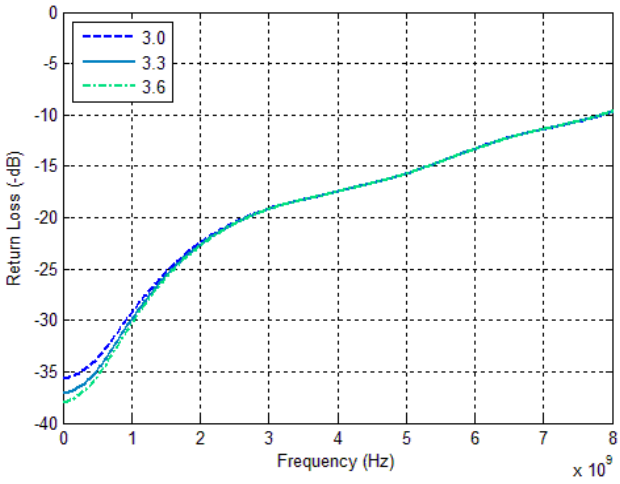


Figure 14. Isolation vs. Temp (RFX-RFX)

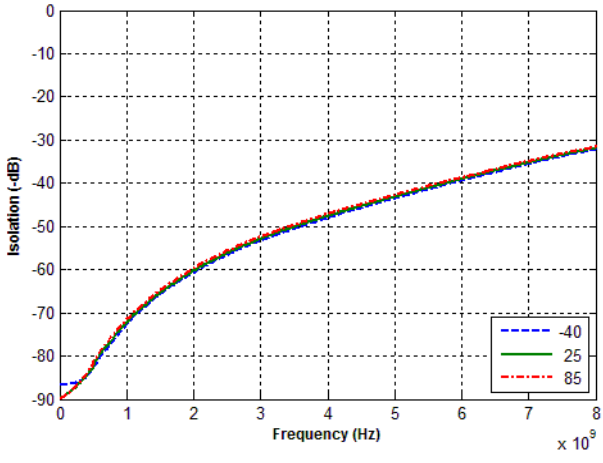
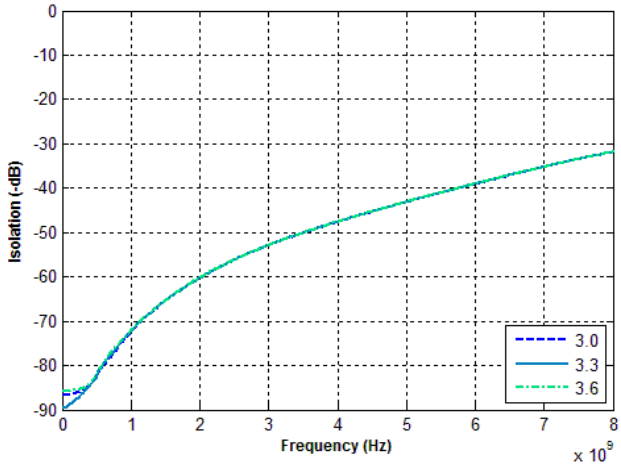


Figure 15. Isolation vs. V_{DD} (RFX-RFX)



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Typical Performance Data @ 25°C and V_{DD} = 3.3V, unless otherwise specified

Figure 16. Isolation vs. Temp (RFC-RFX)

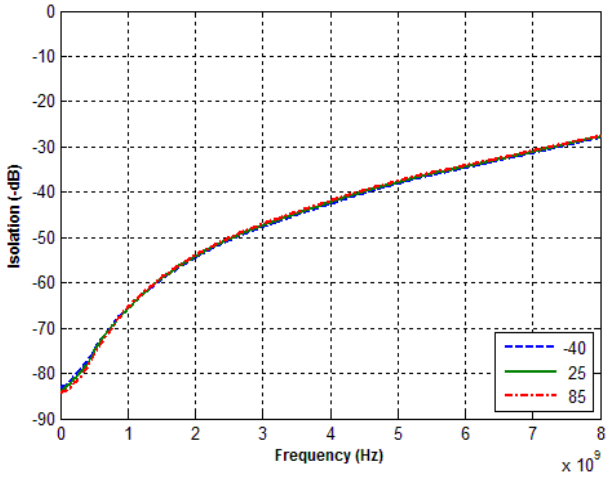


Figure 17. Isolation vs. V_{DD} (RFC-RFX)

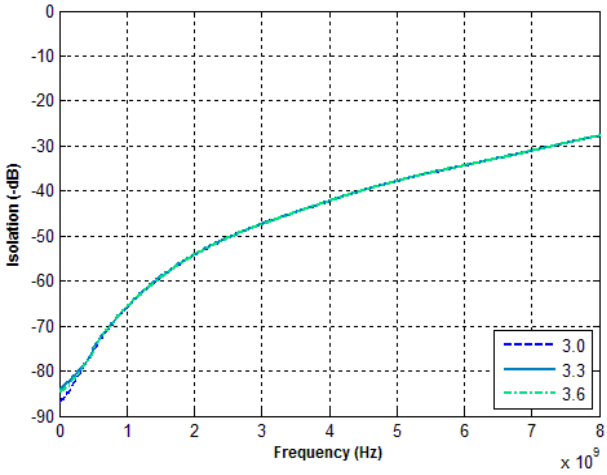
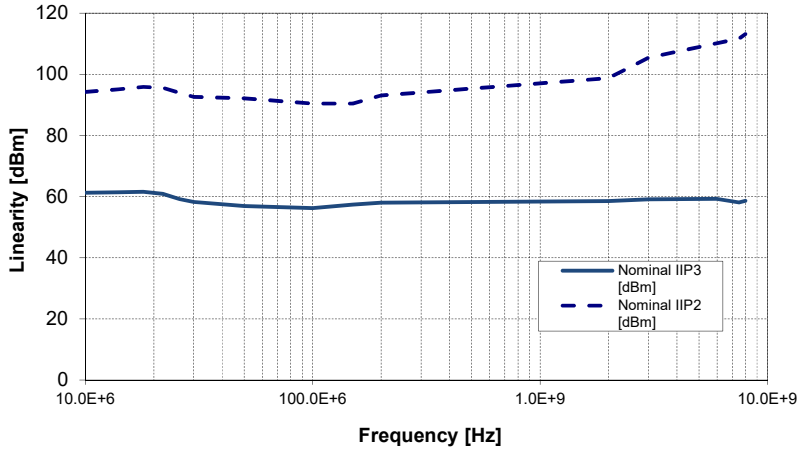


Figure 18. Linearity Performance



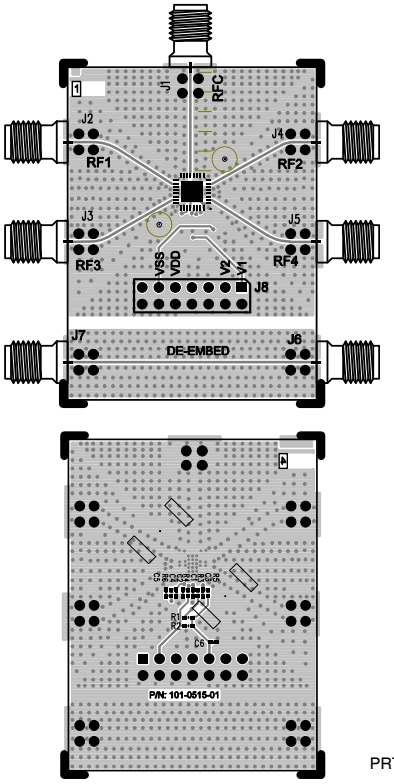
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Evaluation Kit

The SP4T switch EK Board was designed to ease customer evaluation of pSemi's PE42441. The RF common port is connected through a 50Ω transmission line via the top SMA connector, J1. RF1, RF2, RF3 and RF4 are connected through 50Ω transmission lines via SMA connectors J2, J4, J3 and J5, respectively. A through 50Ω transmission is available via SMA connectors J6 and J7. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a four metal layer material with a total thickness of 62 mils. The dual clad top RF layer is Rogers RO4003 material with an 8 mil RF core and er = 3.55. The middle layers provide ground for the transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 15 mils, trace gaps of 10 mils, and metal

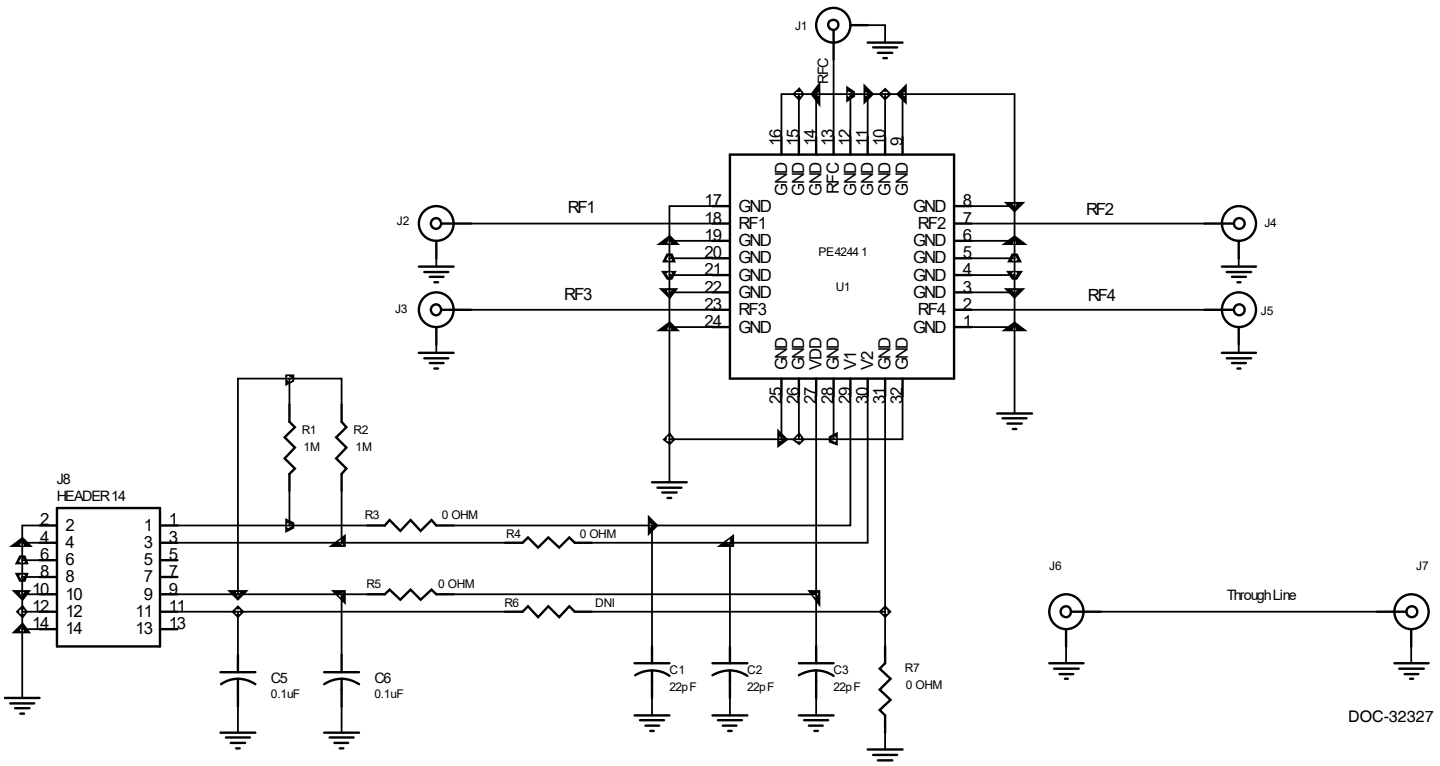
Figure 19. Evaluation Board Layouts



PRT-28605

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Figure 20. Evaluation Board Schematic



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Figure 21. Package Drawing

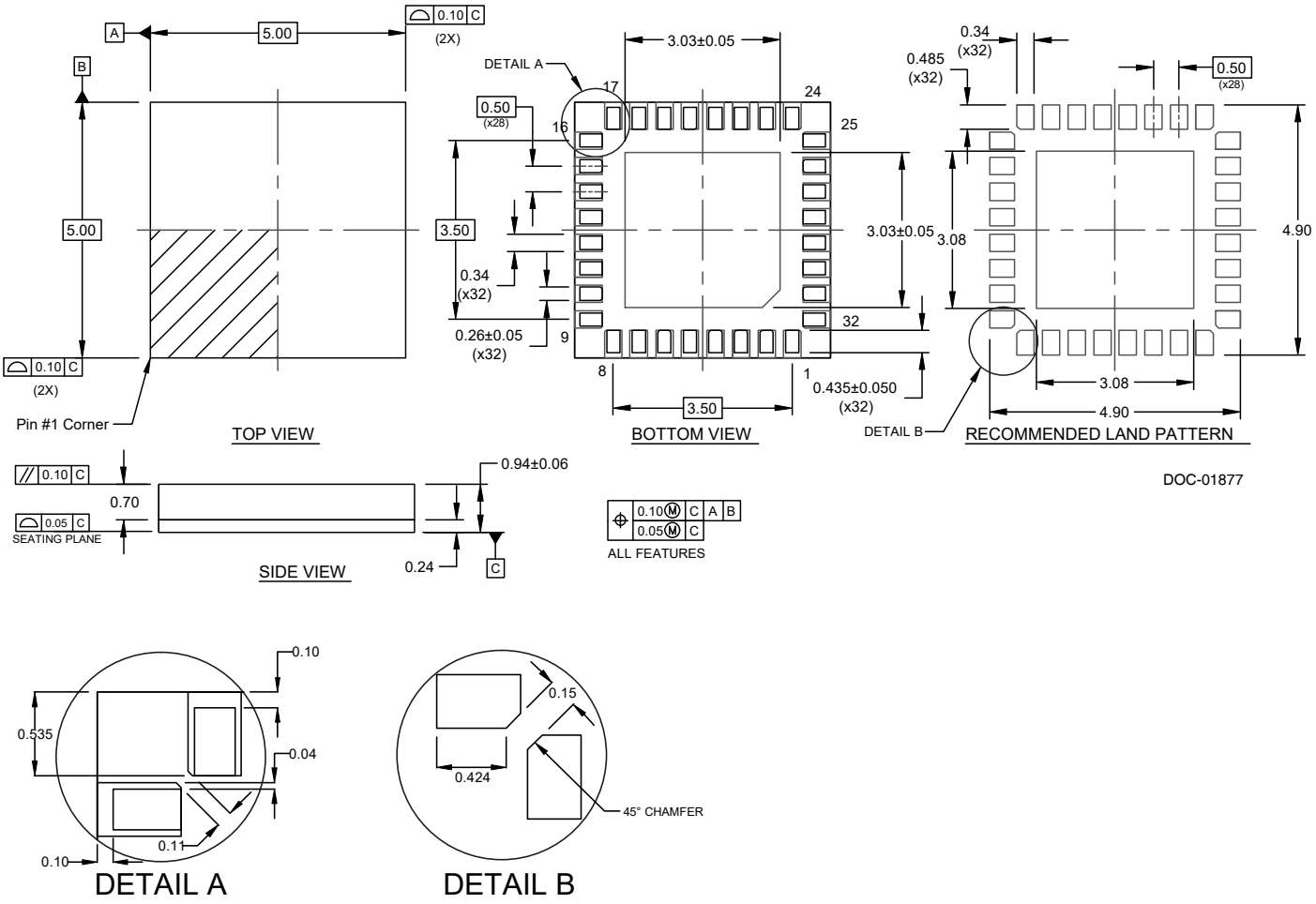
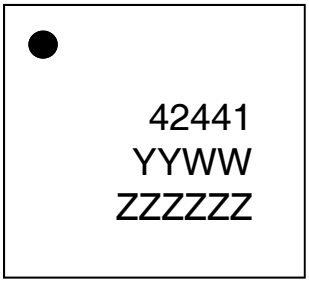


Figure 22. Marking Specifications

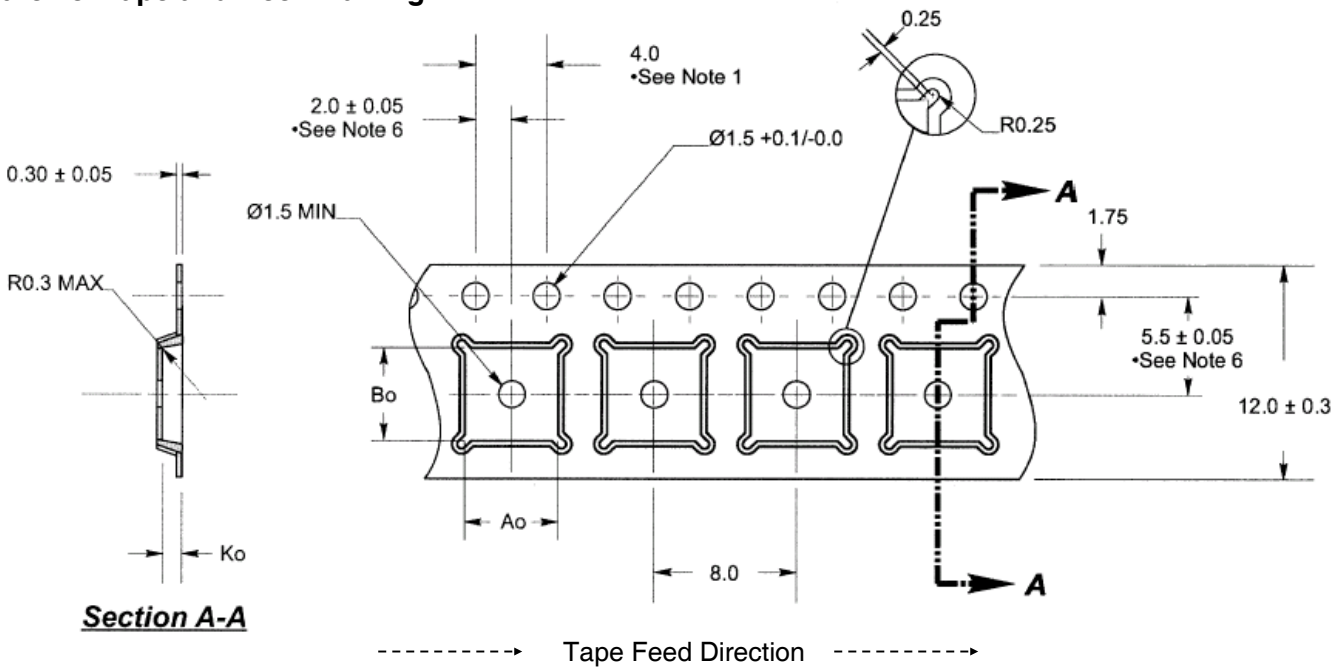


DOC-51207

● = Pin 1 indicator
YYWW = Date code, last two digits of the year and work week
ZZZZZZ = Six digits of the lot number

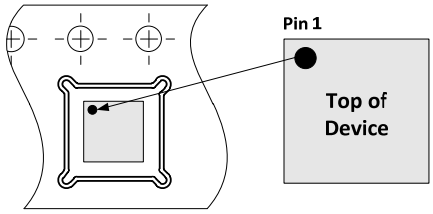
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Figure 23. Tape and Reel Drawing



Notes:
1. 10 sprocket hole pitch cumulative tolerance ±0.02
2. Camber not to exceed 1 mm in 100 mm
3. Material: PS + C
4. Ao and Bo measured as indicated
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole

Ao = 5.25 ± 0.05 mm
Bo = 5.25 ± 0.05 mm
Ko = 1.1 ± 0.05 mm



Device Orientation in Tape

Table 6. Ordering Information

Order Code	Description	Package	Shipping Method
PE42441E-Z	PE42441 SP4T RF switch	Green 32-lead 5x5 mm LGA	3000 units / T&R
EK42441-04	PE42441 Evaluation kit	Evaluation kit	1 / Box

Sales Contact and Information

For sales and contact information please visit www.psemi.com.

Advance Information: The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice. ***Preliminary Specification:*** The datasheet contains preliminary data. Additional data may be added at a later date. pSemi reserves the right to change specifications at any time without notice in order to supply the best possible product. ***Product Specification:*** The datasheet contains final data. In the event pSemi decides to change the specifications, pSemi will notify customers of the intended changes by issuing a CNF (Customer Notification Form).
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